

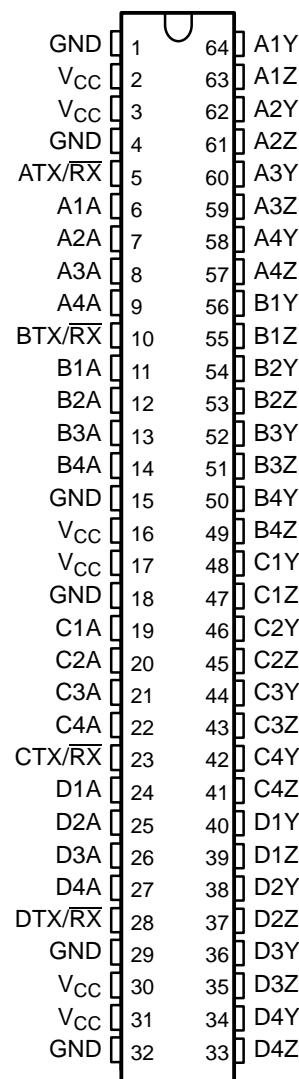
HIGH-SPEED DIFFERENTIAL LINE TRANSCEIVERS

FEATURES

- Sixteen Low-Voltage Differential Transceivers
Designed for Signaling Rates⁽¹⁾ Up to 630
Mbps
- Simplex (Point-to-Point) and Half-Duplex
(Multipoint) Interface
- Typical Differential Output Voltage of 340 mV
Into a 50- Ω Load
- Integrated 110- Ω Line Termination on
'LVDM1677 Product
- Propagation Delay Time:
 - Driver: 2.5 ns Typ
 - Receiver: 3 ns Typ
- Recommended Maximum Transfer Rate:
 - Driver: 650 M-Transfers/s
 - Receiver: 350 M-Transfers/s
- Driver is High Impedance When Disabled or
With $V_{CC} < 1.5$ V for Power Up/Down
Glitch-Free Performance and Hot-Plugging
Events
- Bus-Terminal ESD Protection Exceeds 12 kV
- Low-Voltage TTL (LVTTL) Logic Input Levels
Are 5-V Tolerant
- Packaged in Thin Shrink Small-Outline
Package With 20 mil Terminal Pitch

⁽¹⁾Signaling rate, 1/t, where t is the minimum
unit interval and is expressed in the units
bits/s (bits per second).

SN65LVDM1676DGG (Marked as LVDM1676)
SN65LVDM1677DGG (Marked as LVDM1677)
(TOP VIEW)



DESCRIPTION

The SN65LVDM1676 and SN65LVDM1677 (integrated termination) are sixteen differential line drivers and receivers configured as transceivers that use low-voltage differential signaling (LVDS) to achieve signaling rates in excess of 600 Mbps. These products are similar to TIA/EIA-644 standard compliant devices (SN65LVDS) counterparts except that the output current of the drivers are doubled. This modification provides a minimum differential output voltage magnitude of 247 mV into a 50- Ω load and allows double-terminated lines and half-duplex operation. The receivers detect a voltage difference of 100 mV with up to 1 V of ground potential difference between a transmitter and receiver.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

DESCRIPTION (CONTINUED)

The intended application of this device and signaling technique is for point-to-point baseband data transmission over controlled impedance media of approximately $100\ \Omega$. The transmission media may be printed-circuit board traces, backplanes, or cables. The large number of transceivers integrated into the same substrate along with the low pulse skew of balanced signaling, allows extremely precise timing alignment of clock and data for synchronous parallel data transfers. (Note: The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media, the noise coupling to the environment, and other system characteristics.)

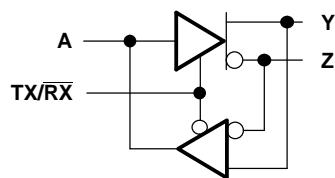
The SN65LVDM1676 and SN65LVDM1677 are characterized for operation from -40°C to 85°C .

FUNCTION TABLE⁽¹⁾

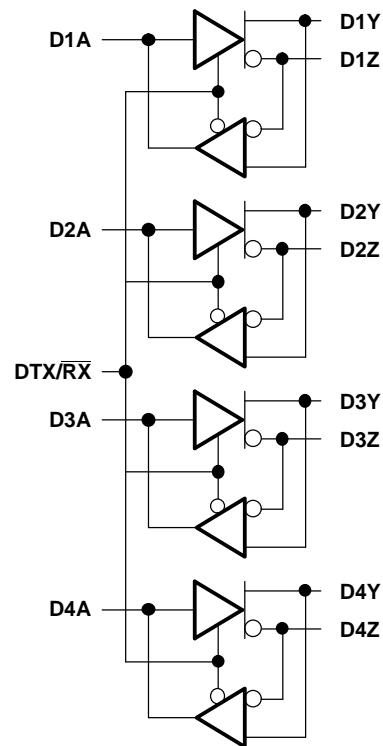
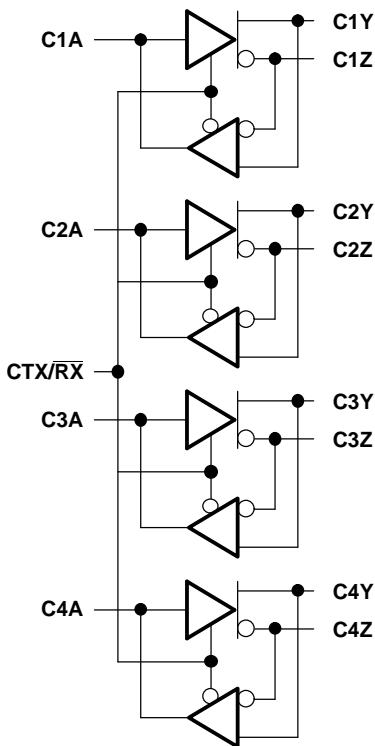
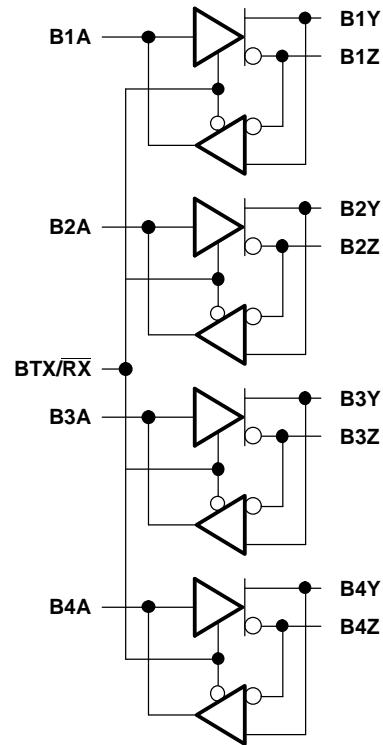
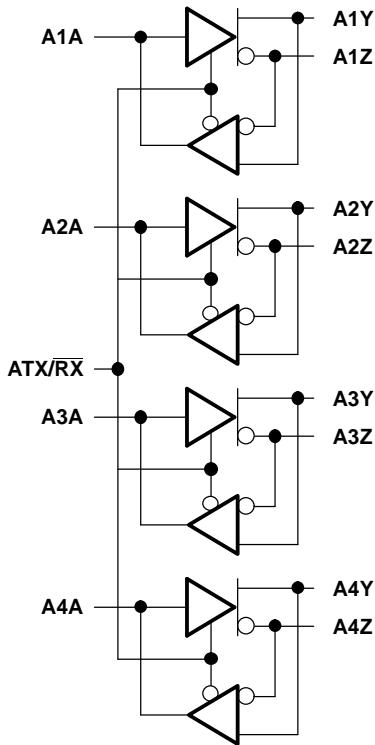
INPUTS		OUTPUTS		
(Y - Z)	TX/RX	A	Y	Z
$V_{ID} \geq 100\ \text{mV}$	L	NA	Z	Z
$-100\ \text{mV} < V_{ID} < 100\ \text{mV}$	L	NA	Z	Z
$V_{ID} \leq -100\ \text{mV}$	L	NA	Z	Z
Open circuit	L	NA	Z	Z
NA	H	L	L	H
NA	H	H	H	L

(1) H = high level, L = low level, Z = high impedance, ? = indeterminate

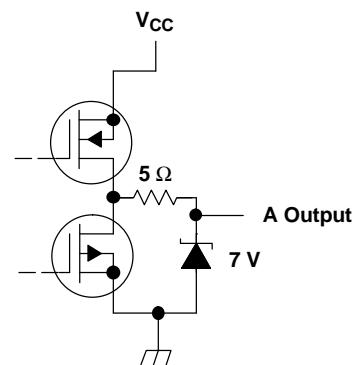
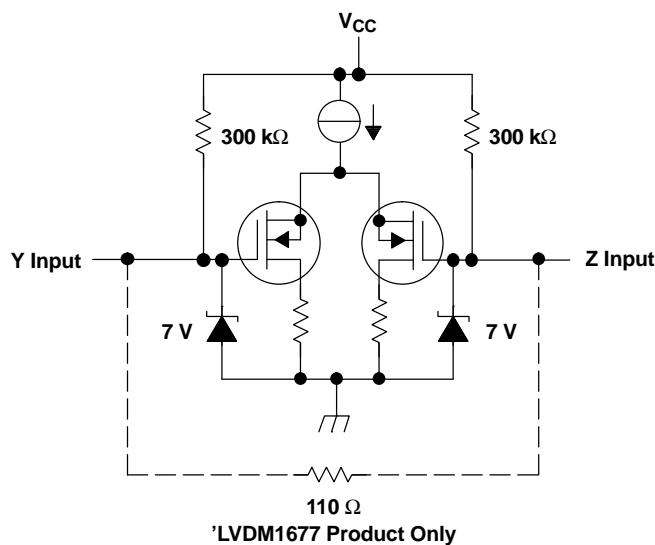
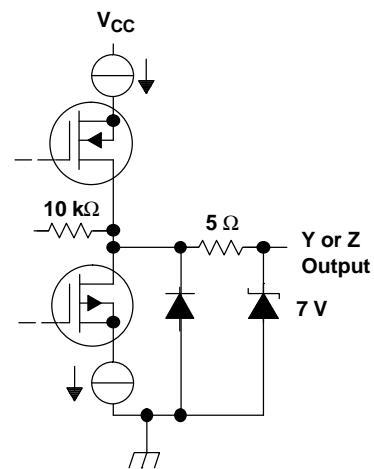
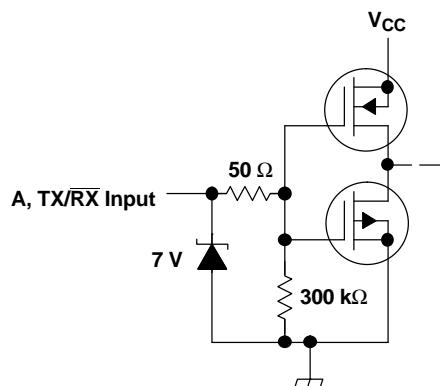
LVD Transceiver



LOGIC DIAGRAM (POSITIVE LOGIC)



EQUIVALENT INPUT AND OUTPUT SCHEMATIC DIAGRAMS



ABSOLUTE MAXIMUM RATINGS

 over operating free-air temperature range (unless otherwise noted)⁽¹⁾

			UNIT
V_{CC} , see ⁽²⁾	Supply voltage range		-0.5 V to 4 V
	Input voltage range	A, TX/RX	-0.5 V to 6 V
		Y or Z	-0.5 V to 4 V
V_{ID} , (SN65LVDM1677 only)	Differential input voltage magnitude	1 V	
I_O	Receiver output current		$\pm 20\text{mA}$
	Electrostatic discharge	Y, Z, and GND, see ⁽³⁾	Class 3, A:8 kV, B:600 V
	Continuous power dissipation		Class 3, A:7 kV, B:500 V
	Storage temperature range		-65°C to 150°C
	Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds		260°C

- (1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.
- (3) Tested in accordance with MIL-STD-883C Method 3015.7.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	OPERATING FACTOR ⁽¹⁾ ABOVE $T_A = 25^\circ\text{C}$	$T_A = 85^\circ\text{C}$ POWER RATING
DGG	2094 mW	16.7 mW/°C	1089 mW

- (1) All typical values are at 25°C and with a 3.3-V supply.

RECOMMENDED OPERATING CONDITIONS

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	3	3.3	3.6	V
V_{IH}	High-level input voltage	2			
V_{IL}	Low-level input voltage			0.8	
$ V_{ID} $	Magnitude of differential input voltage	0.1	0.6		
V_{IC}	Common-mode input voltage	$\frac{ V_{ID} }{2}$	$2.4 - \frac{ V_{ID} }{2}$	$V_{CC} - 0.8$	V
I_{OL}	Receiver low-level output current			8	mA
I_{OH}	Receiver high-level output current	-8			
T_A	Operating free-air temperature	-40		85	°C

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
DEVICE					
I_{CC}	Supply current	Driver enabled, receiver disabled, $R_L = 50\ \Omega$	140	175	mA
		Driver disabled, receiver enabled, no load	45	60	

- (1) All typical values are at 25°C and with a 3.3-V supply.

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DRIVER					
JV_{ODJ}	Differential output voltage magnitude	247	340	454	
ΔJV_{ODJ}	Change in differential output voltage magnitude between logic states	-50		50	mV
$V_{OC(ss)}$	Steady-state common-mode output voltage	1.125	1.375		V
$\Delta V_{OC(ss)}$	Change in steady-state common-mode output voltage between logic states	-50	50		mV
$V_{OC(pp)}$	Peak-to-peak common-mode output voltage	50	150		mV
I_{IH}	High-level input current	3	20		μ A
I_{IL}	Low-level input current	2	10		μ A
I_{OS}	Short-circuit output current	10			mA
$I_{O(OFF)}$	Power-off output current	10			mA
C_{IN}	Input capacitance	5			pF

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
RECEIVER					
V_{IT+}	Positive-going differential input voltage threshold	100			mV
V_{IT-}	Negative-going differential input voltage threshold	100			
V_{OH}	High-level output voltage	2.4			V
V_{OL}	Low-level output voltage	0.4			V
I_I	Input current (Y or Z inputs)	-24	-40		μ A
	$V_I = 0 \text{ V}$	-1.2	-8		
	$V_I = 2.4 \text{ V}$	5	10		μ A
I_{ID}	Differential input current $ I_{IY} - I_{IZ} $ (inputs)	1.5	2.2		mA
$I_{I(OFF)}$	Power-off input current (Y or Z inputs)	± 25			μ A

(1) All typical values are at 25°C and with a 3.3-V supply.

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
DRIVER					
t_{PLH}	$R_L = 50 \Omega$, $C_L = 10 \text{ pF}$, See Figure 4	1.3	2.5	3.6	ns
t_{PHL}		1.3	2.5	3.6	
t_r		0.5	1.2		
t_f		0.5	1.2		
$t_{sk(p)}$		0.1	0.6		
$t_{sk(o)}$		0.1	0.4		
$t_{sk(pp)}$			1		
t_{PZH}		11	20		
t_{PZL}	Figure 5	10	20		
t_{PHZ}		3	10		
t_{PLZ}		3	10		
RECEIVER					
t_{PLH}	$C_L = 10 \text{ pF}$, See Figure 7	1.5	3	4.5	ns
t_{PHL}		1.5	3	4.5	
t_r		0.6	1.6		
t_f		0.6	1.6		
$t_{sk(p)}$		0.2	0.8		
$t_{sk(o)}$		0.7	1.2		
$t_{sk(pp)}$			1		
t_{PZH}		9	15		
t_{PZL}	Figure 8	8	15		
t_{PHZ}		12	20		
t_{PLZ}		11	20		

(1) All typical values are at 25°C and with a 3.3-V supply.

 (2) $t_{sk(o)}$ is the skew between specified outputs of a single device with all driving inputs connected together and the outputs switching in the same direction while driving identical specified loads.

 (3) $t_{sk(pp)}$ is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

 (4) $t_{sk(o)}$ is the skew between specified outputs of a single device with all driving inputs connected together and the outputs switching in the same direction while driving identical specified loads.

 (5) $t_{sk(pp)}$ is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

PARAMETER MEASUREMENT INFORMATION

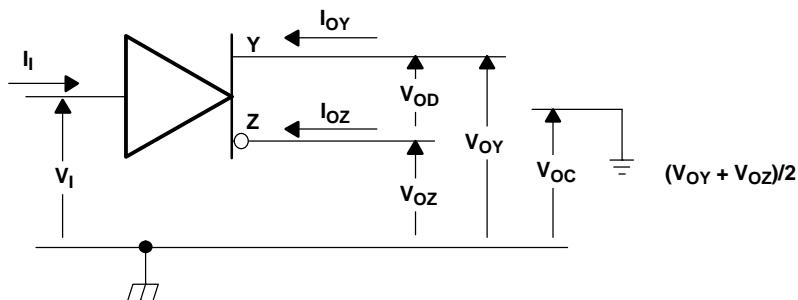


Figure 1. Driver Voltage and Current Definitions

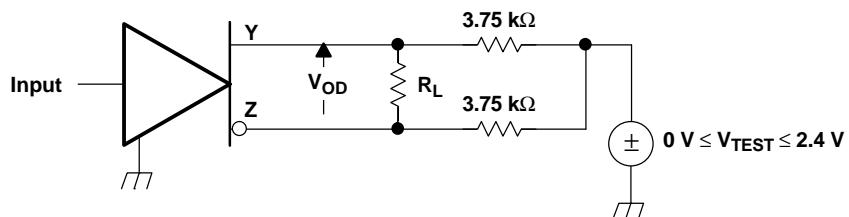
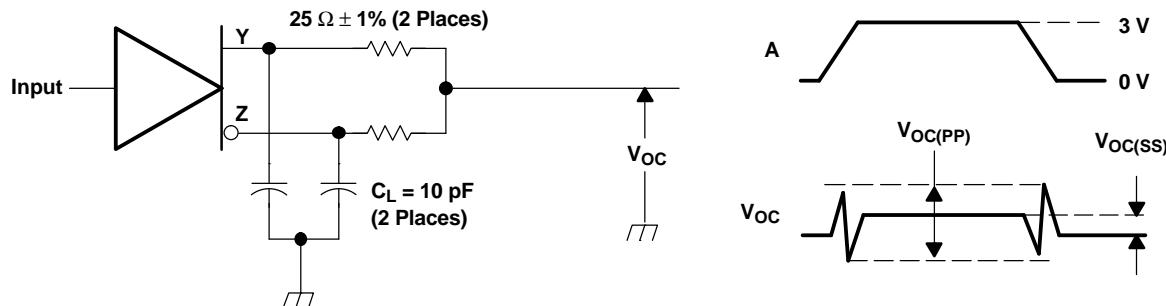


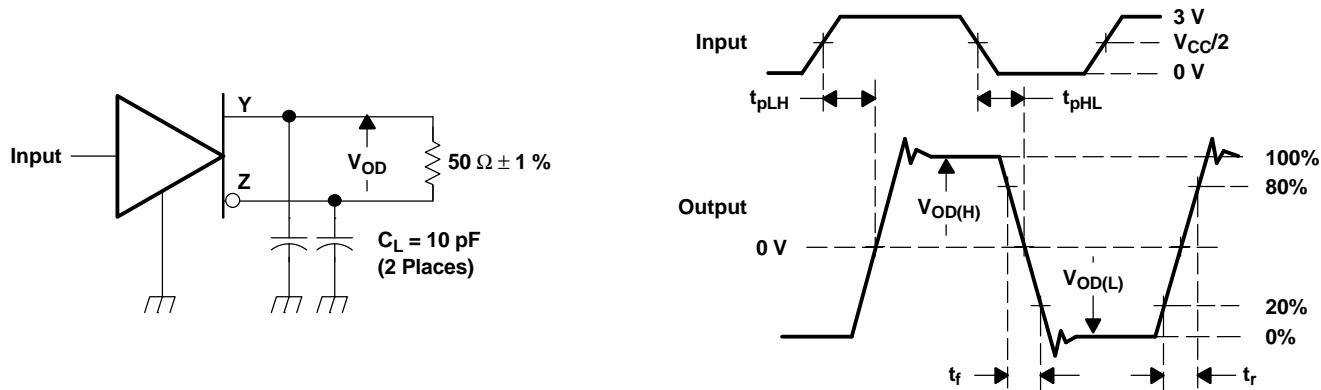
Figure 2. Driver V_{OD} Test Circuit



A. NOTE: All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 500 ± 10 ns. C_L includes instrumentation and fixture capacitance within 0.06 m of the D.U.T. The measurement of $V_{OC(PP)}$ is made on test equipment with a -3 dB bandwidth of at least 300 MHz.

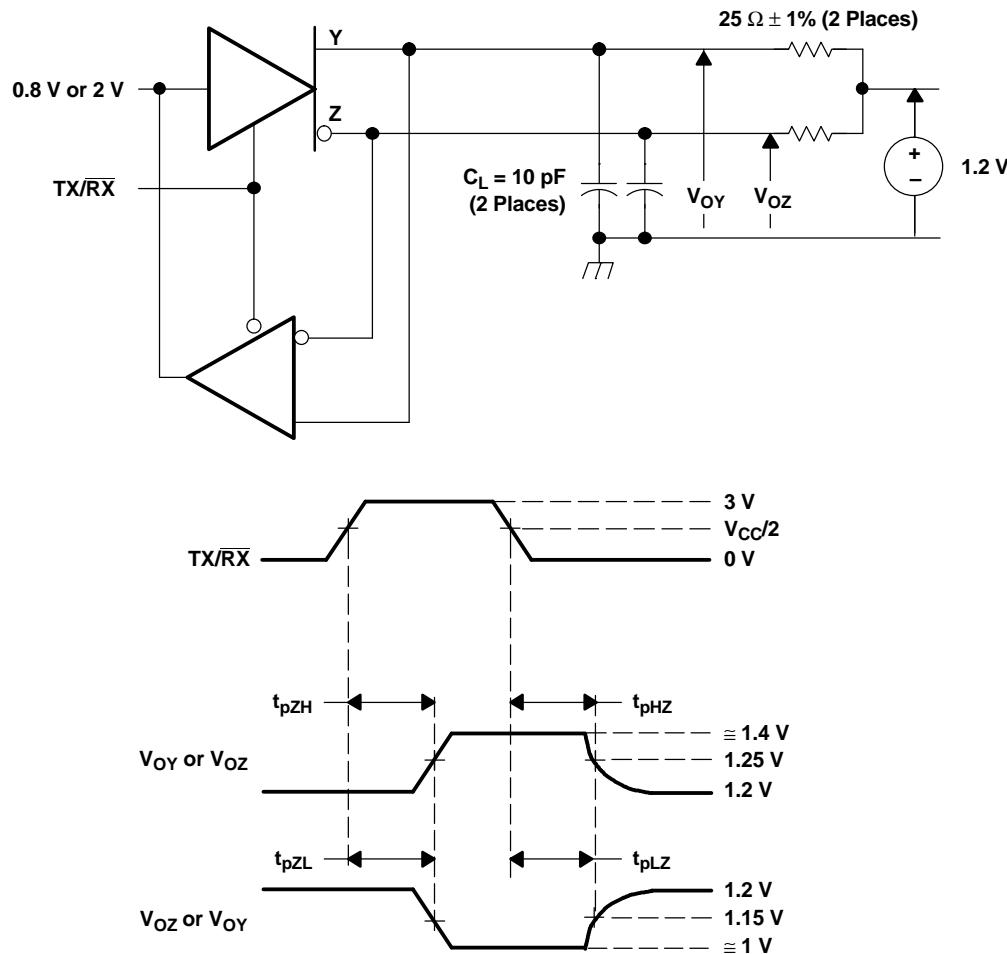
Figure 3. Test Circuit and Definitions for the Driver Common-Mode Output Voltage

PARAMETER MEASUREMENT INFORMATION (continued)



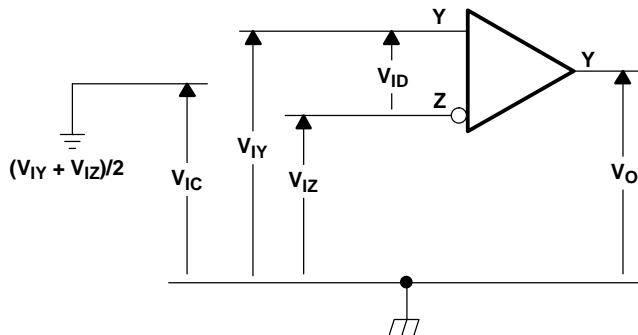
A. All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1 \text{ ns}$, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = $10 \pm 0.2 \text{ ns}$. C_L includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

Figure 4. Test Circuit, Timing, and Voltage Definitions for the Differential Output Signal

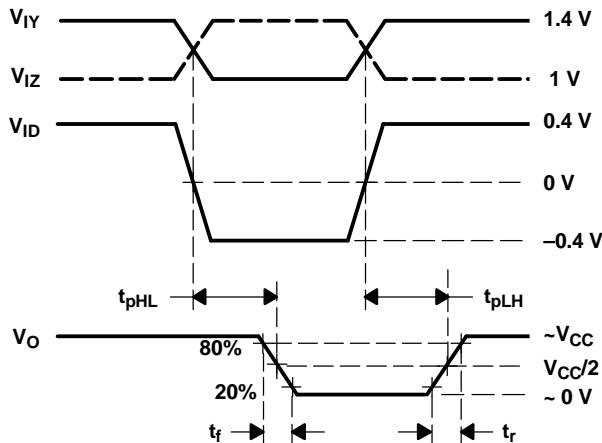
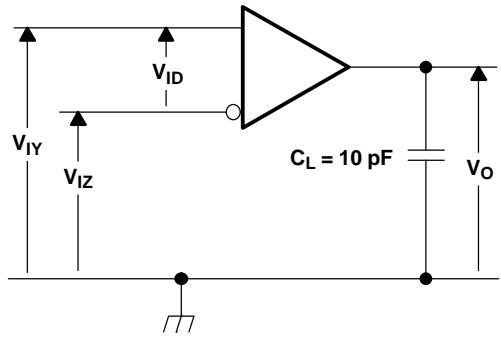


A. All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1 \text{ ns}$, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = $500 \pm 10 \text{ ns}$. C_L includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

Figure 5. Enable and Disable Time Circuit and Definitions

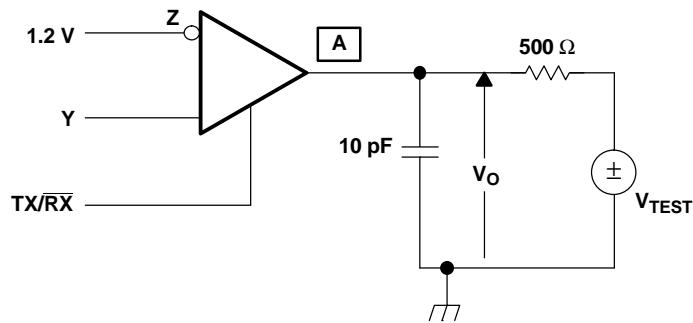
PARAMETER MEASUREMENT INFORMATION (continued)

Figure 6. Voltage Definitions
Table 1. Receiver Minimum and Maximum Input Threshold Test Voltages

APPLIED VOLTAGES		RESULTING DIFFERENTIAL INPUT VOLTAGE	RESULTING COMMON-MODE INPUT VOLTAGE
V _{IY}	V _{IZ}	V _{ID}	V _{IC}
1.25 V	1.15 V	100 mV	1.2 V
1.15 V	1.25 V	-100 mV	1.2 V
2.4 V	2.3 V	100 mV	2.35 V
2.3 V	2.4 V	-100 mV	2.35 V
0.1 V	0 V	100 mV	0.05 V
0 V	0.1 V	-100 mV	0.05 V
1.5 V	0.9 V	600 mV	1.2 V
0.9 V	1.5 V	-600 mV	1.2 V
2.4 V	1.8 V	600 mV	2.1 V
1.8 V	2.4 V	-600 mV	2.1 V
0.6 V	0 V	600 mV	0.3 V
0 V	0.6 V	-600 mV	0.3 V



A. All input pulses are supplied by a generator having the following characteristics: t_f or $t_r \leq 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 10 ± 0.2 ns. C_L includes instrumentation and fixture capacitance within 0.06 m of the D.U.T.

Figure 7. Timing Test Circuit and Waveforms



NOTE: All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 500 ± 10 ns. C_L includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

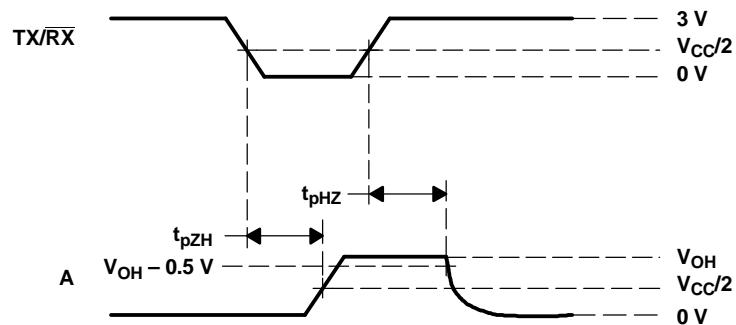
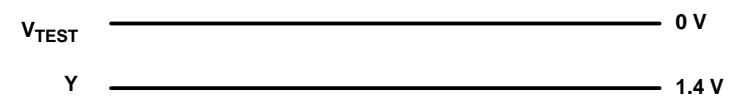
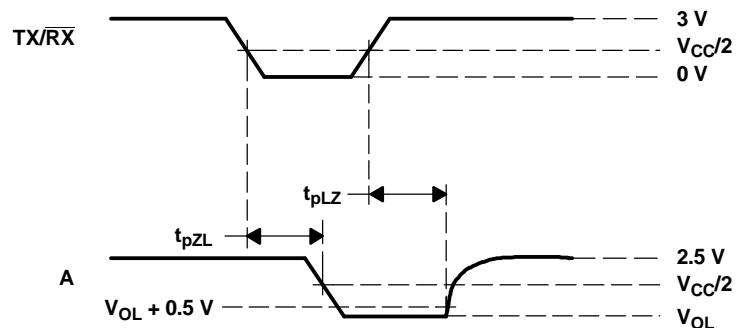
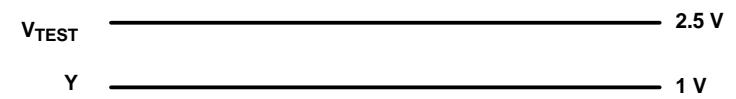


Figure 8. Enable/Disable Time Test Circuit and Waveforms

TYPICAL CHARACTERISTICS

COMMON-MODE INPUT VOLTAGE

vs

DIFFERENTIAL INPUT VOLTAGE

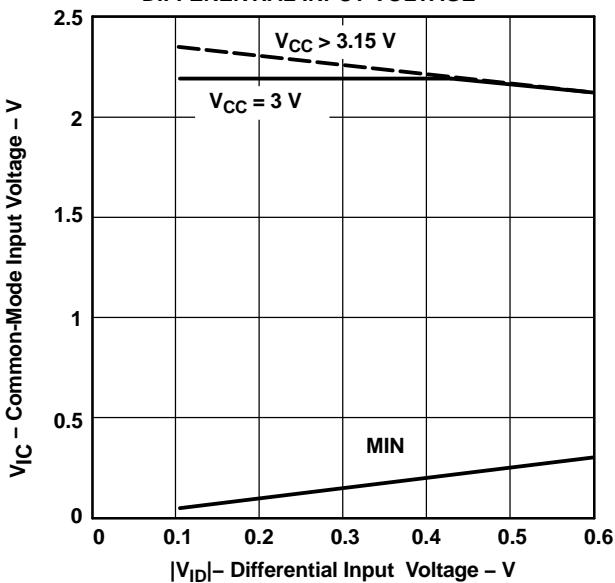


Figure 9.

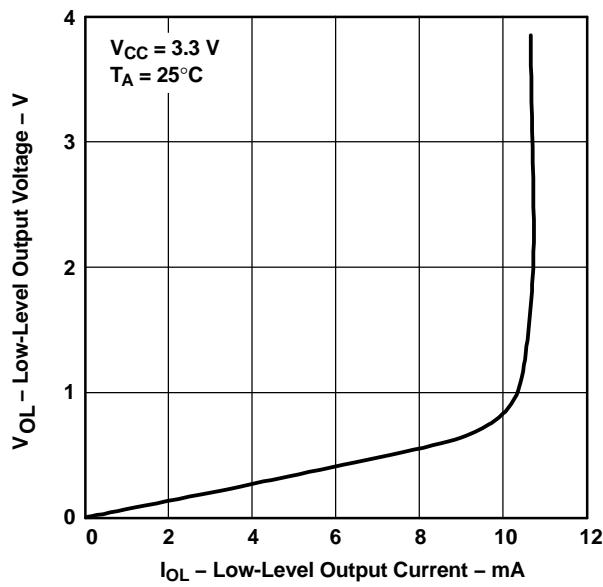
DRIVER
LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT

Figure 10.

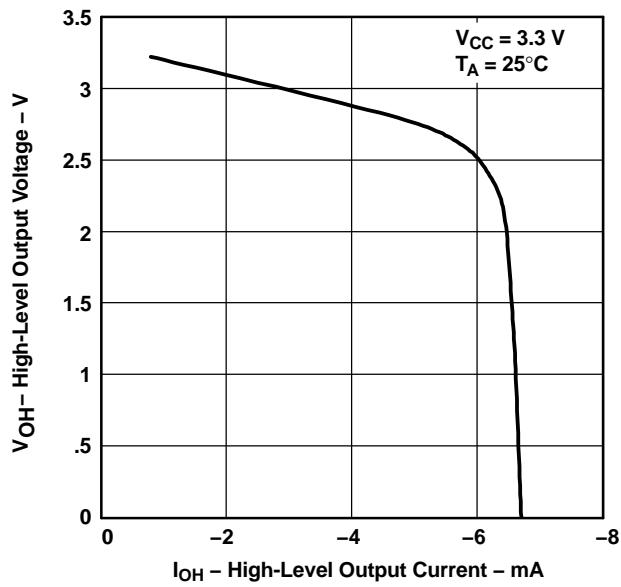
DRIVER
HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

Figure 11.

TYPICAL CHARACTERISTICS (continued)

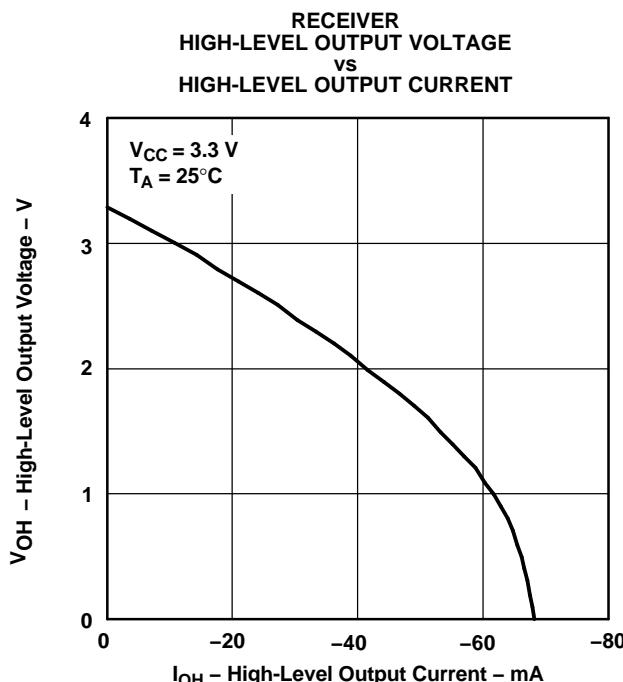


Figure 12.

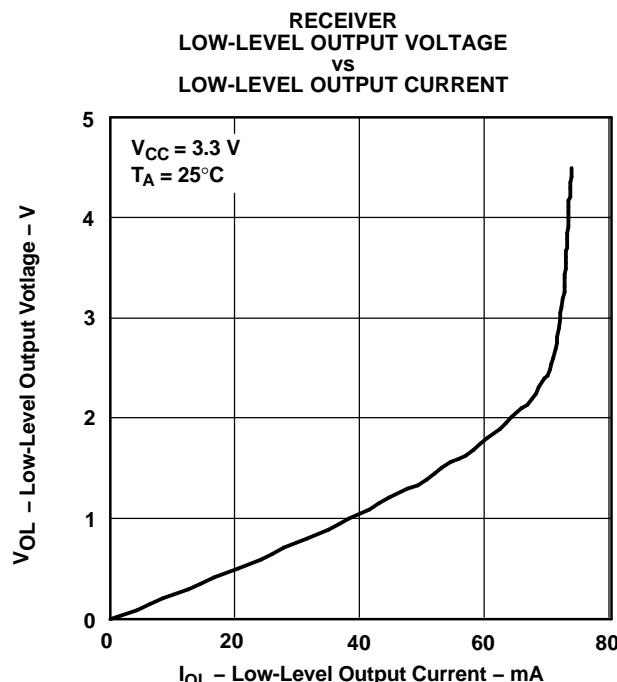


Figure 13.

TYPICAL CHARACTERISTICS

DRIVER EYE PATTERN

TEST CONDITIONS

- $V_{CC} = 3.3 \text{ V}$
- $T_A = 25^\circ\text{C}$ (ambient temperature)
- All 16 channels switching simultaneously with NRZ data. Scope is triggered at the same frequency with pulse. Input signal level = 0 to 3 V single ended.
- Resistive loading with no added capacitance

TYPICAL CHARACTERISTICS (continued)

EQUIPMENT

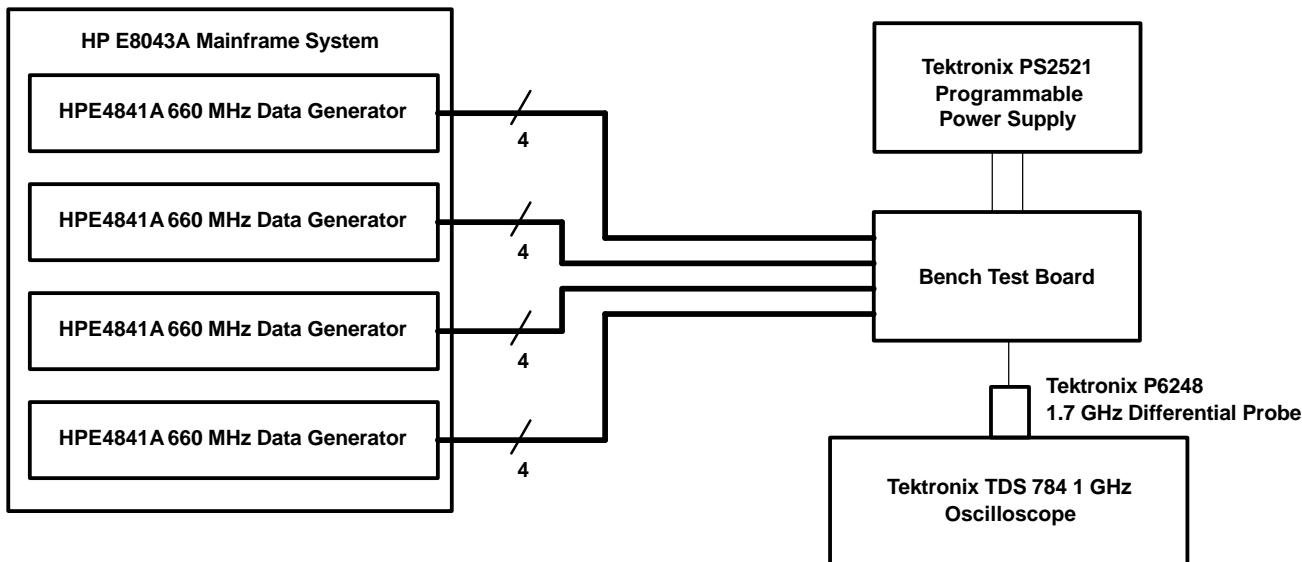
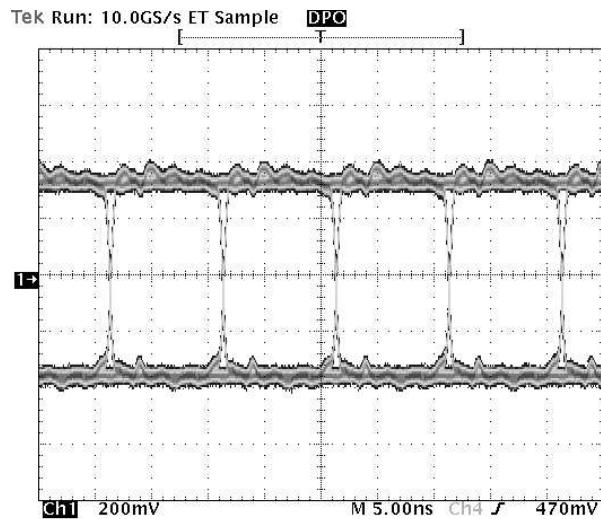
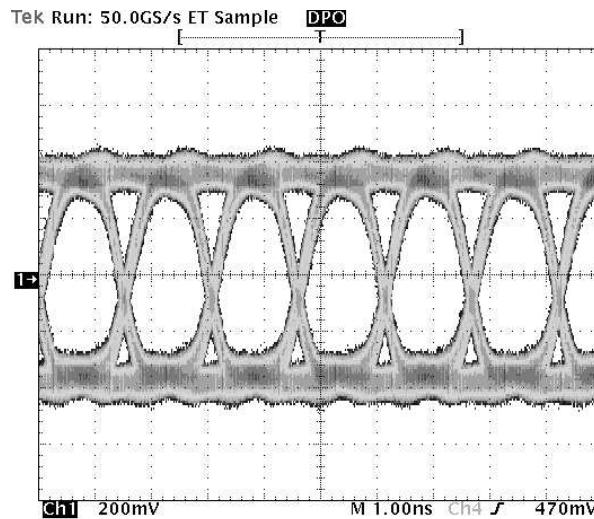


Figure 14. Driver Test Equipment Setup



100 Mbps



650 Mbps

Figure 15. Typical Driver Eye Pattern for the SN65LVDM1676

RECEIVER EYE PATTERN

TEST CONDITIONS

- $V_{CC} = 3.3$ V
- $T_A = 25^\circ\text{C}$ (ambient temperature)
- All 16 channels switching simultaneously with NRZ data. Scope is pulse-triggered simultaneously with NRZ data. Input signal level is 1 V to 1.4 V differential.
- 50- Ω resistive loading with no added capacitance

TYPICAL CHARACTERISTICS (continued)

EQUIPMENT

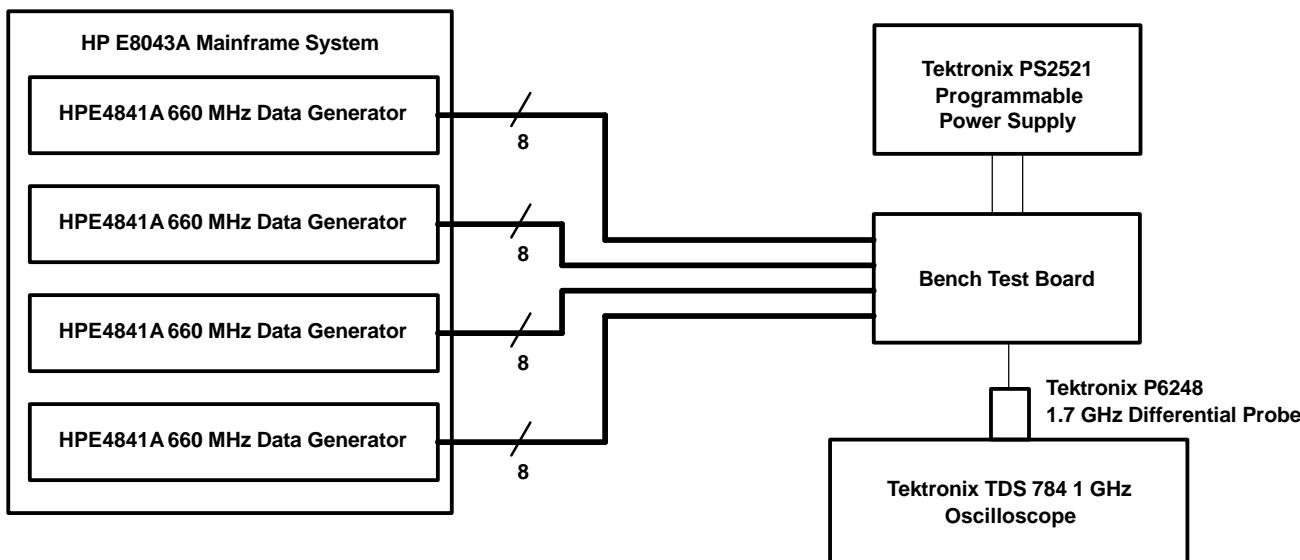


Figure 16. Receiver Test Equipment Setup

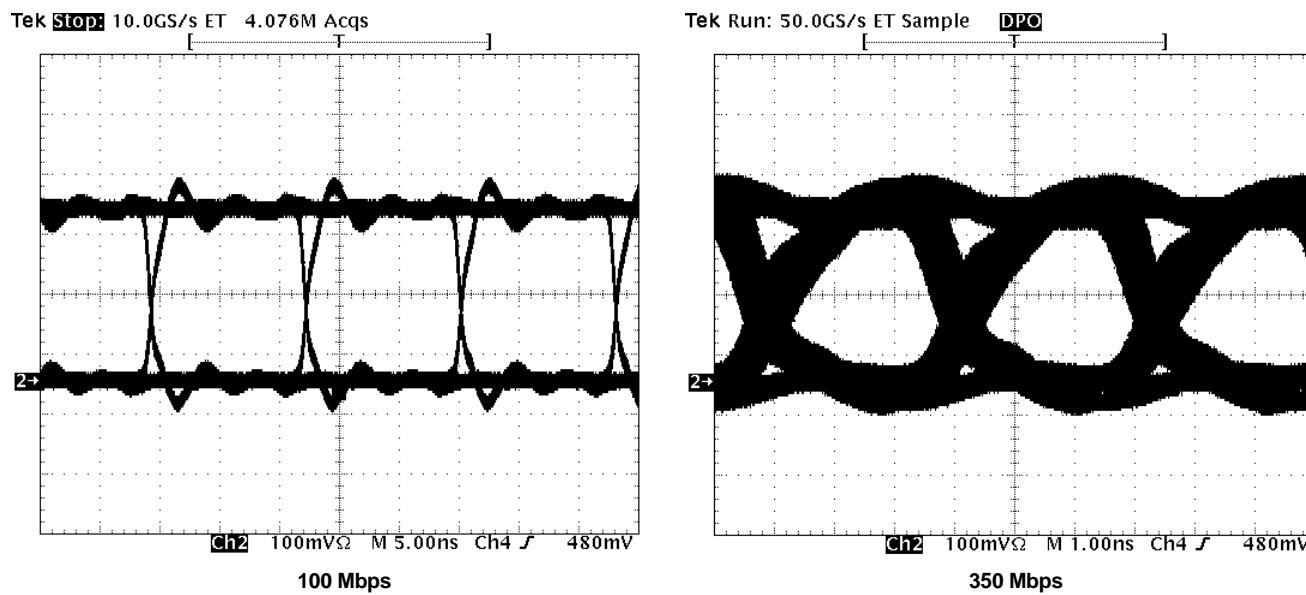


Figure 17. Typical Receiver Eye Pattern for the SN65LVDM1677

APPLICATION INFORMATION

FAIL SAFE

One of the most common problems with differential signaling applications is how the system responds when no differential voltage is present on the signal pair. The LVDS receiver is like most differential line receivers, in that its output logic state can be indeterminate when the differential input voltage is between -50 mV and 50 mV and within its recommended input common-mode voltage range. TI's LVDS receiver is different, however, in how it handles the open-input circuit situation.

Open-circuit means that there is little or no input current to the receiver from the data line itself. This could be when the driver is in a high-impedance state or the cable is disconnected. When this occurs, the LVDS receiver will pull each line of the signal pair to near V_{CC} through 300-k Ω resistors as shown in Figure 18. The fail-safe feature uses an AND gate with input voltage thresholds at about 2.3 V to detect this condition and force the output to a high-level, regardless of the differential input voltage.

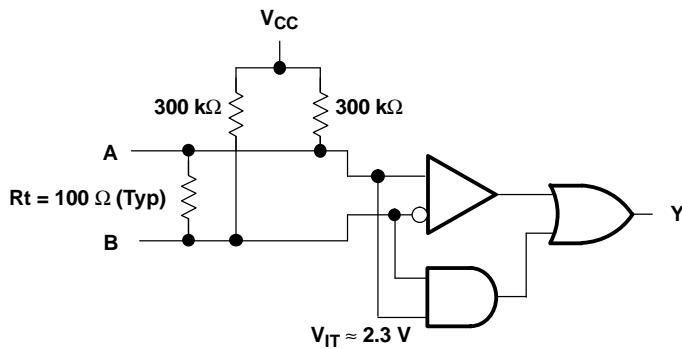


Figure 18. Open-Circuit Fail Safe of the LVDS Receiver

It is only under these conditions that the output of the receiver will be valid with less than a 50-mV differential input voltage magnitude. The presence of the termination resistor, R_t , does not affect the fail-safe function as long as it is connected as shown in the figure. Other termination circuits may allow a dc current to ground that could defeat the pullup currents from the receiver and the fail-safe feature.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN65LVDM1676DGG	ACTIVE	TSSOP	DGG	64	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDM1676DGGG4	ACTIVE	TSSOP	DGG	64	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDM1676DGGR	ACTIVE	TSSOP	DGG	64	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDM1676DGGRG4	ACTIVE	TSSOP	DGG	64	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDM1677DGG	ACTIVE	TSSOP	DGG	64	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDM1677DGGG4	ACTIVE	TSSOP	DGG	64	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDM1677DGGR	ACTIVE	TSSOP	DGG	64	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
SN65LVDM1677DGGRG4	ACTIVE	TSSOP	DGG	64	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

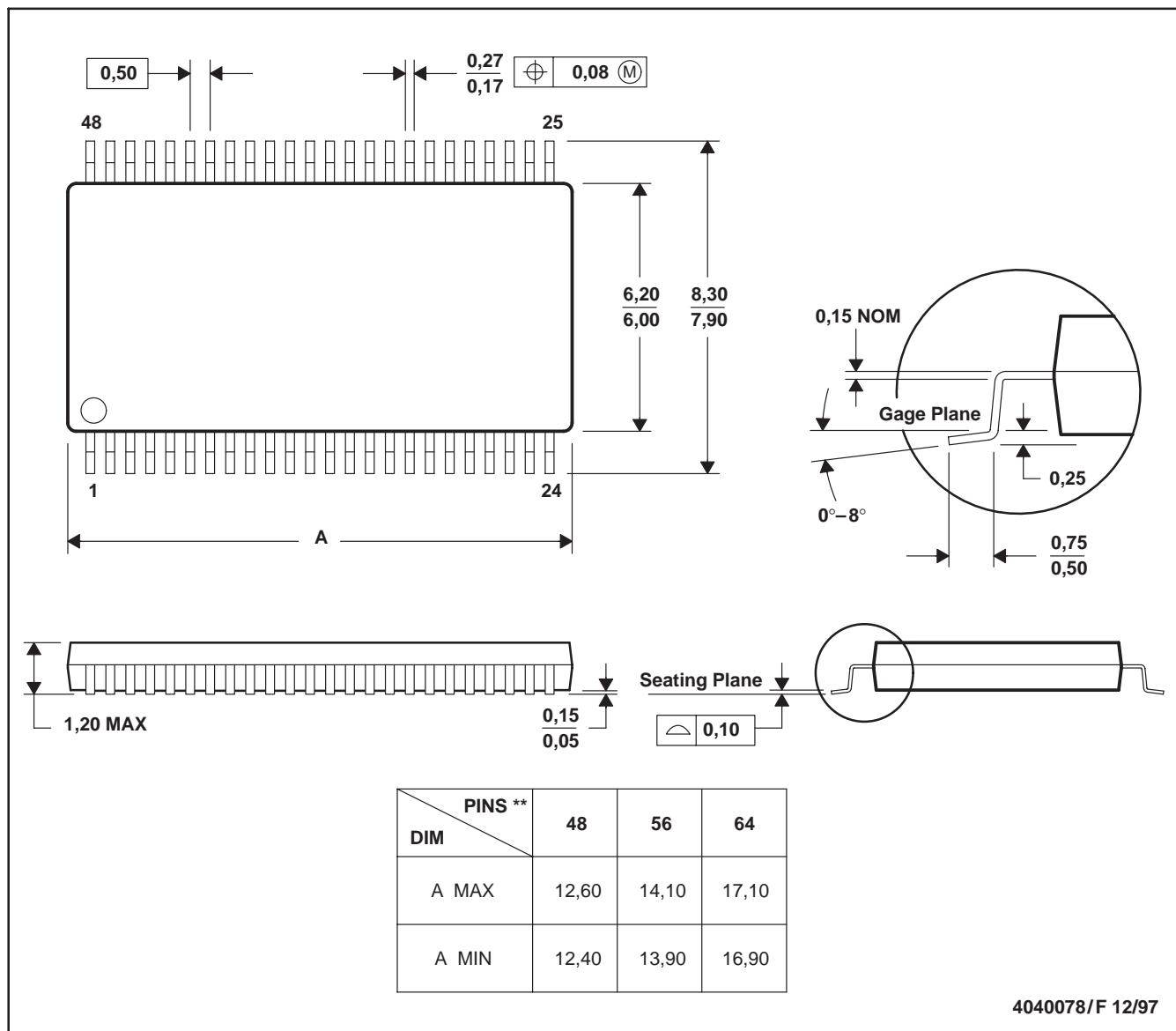
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DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

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